

Tomcat K8SH

///

S3850

Revision 1.10

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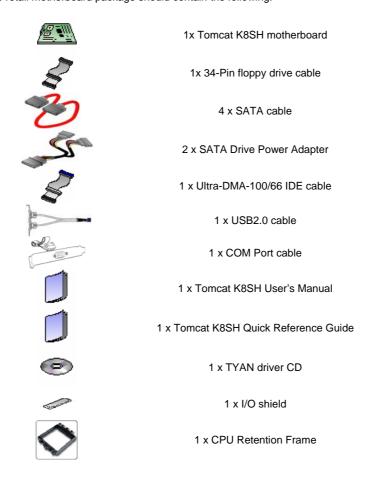
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Before you begin...

Check the box contents!

The retail motherboard package should contain the following:



If any of these items are missing, please contact your vendor/dealer for replacement before continuing with the installation process.

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http://www.TYAN.com

Chapter 1: Introduction

1.00 - Congratulations!

You have purchased one of the most powerful AMD Opteron[™] processor solutions, the Tomcat K8SH S3850. The Tomcat K8SH S3850 features an integrated high bandwidth memory controller for superior productivity. The solution also employs HyperTransport[™] chipset technology to increase overall performance by removing or reducing I/O bottlenecks. Designed around the use of low profile I/O ports with strategically placed DIMM slots to allow maximum airflow across the motherboard for efficient system cooling. The Tomcat K8SH S3850 also features an ATX form factor, Single or Dual Gigabit Ethernet port, an onboard XGI XG20 VGA controllers, and an onboard Quad channel Serial ATA, which provides a versatile solution for your server needs.

Remember to visit TYAN's Website at http://www.tyan.com. There you can find information on all of TYAN's products with FAQs, distributors list and BIOS setting explanations.

1.01 - Hardware Specifications

Processor

- Single μPGA 939-pin socket
- Supports AMD Opteron[™] 100 series single core & dual core processor
- Up to 800 MHz Hyper-Transport link support

Chipset

- Broadcom HT1000
- NS PC87417 Super I/O chip

Memory

- 128-bit dual channel memory bus
- Four 184-pin DDR DIMM sockets
- Supports up to 8GB of unbuffered DDRI 400/333
- Supports PC2100, PC2700 and PC3200 DDRI memory

Expansion Slots

- One 64-bit, 133MHz (3.3V) PCI-X slot
- Four 32-bit, 33MHz PCI v2.3 slots
- Tyan TARO™ SO-DIMM
- Total of five usable slots

Integrated LAN Controllers

- Two Intel i82541PI GbE LAN controllers
- Operating on PCI 32-bit/33MHz bus
- With ASF 2.0/WfM/Teaming support

Integrated I/O

- One floppy connector supports up to two drives
- One IDE connectors for two IDE devices
- Two USB 2.0 Headers (via cable, 2 x 4pin)
- 2 x 25 connector for Tyan IPMI SMDC card (M3291)
- Four SATA ports
- One COM2 header

Back Panel I/O Ports

- One PS/2 Keyboard & Mouse ports
- Two RJ45 10/100/1000 Base-T port w/ activity LED
- Two USB 2.0 ports
- One 9-pin UART Serial port
- One 15-pin VGA port

BIOS

- AMI BIOS® on 8Mbit LPC Flash ROM
- Serial Console Redirect
- USB boot supported
- Supports ACPI
- PnP, DMI 2.0, WfM 2.0 Power Management

Integrated 2D Graphics

- XGI XG20 graphics controller
- 16MB Frame Buffer of video memory

Integrated SATA Controller

- Supports four SATA II ports running at 1.5Gb/s with NCQ (SATAII Phase I)
- Supports four-channel SATA RAID (RAID 0, 1, 5, 10)

Power

- Onboard 4-phase VRD
- EPS12V (24+8) power connectors

System Management

- One Analog Device ADT7476
- Temperature and voltage monitoring
- One (1) 3+1-pin CPU fan header with tachometer monitoring and smart FAN control
- Six (6) 3+1-pin system fan headers with tachometer monitoring, all of them support smart FAN control
- One 2x7-pin fan connector (reserve to support TYAN FAN Adapter Board---M1012)
- Watchdog timer support

Form Factor

- ATX footprint
- 12" x 9.6"; 305mm x 244mm
- 6-layer board

Regulatory

- FCC Class B (Declaration of Conformity)
- European Community CE (Declaration of Conformity)

Software Specifications

RHEL4.0 (64-bit)

OS (Operating System) Support

Microsoft Windows 2000 SP4
Microsoft Windows XP SP2 (32-bit)
Microsoft Windows XP SP1 (64-bit)
Microsoft Windows Server 2003 SP1 (32-bit & 64bit)
SUSE LINUX 9.0 SP3 (64-bit)
SUSE LINUX Professional 9.1 (64-bit)
SUSE LINUX 10.0 (32-bit & 64-bit)
Fedora Core 3 (32-bit) & Fedora Core 3 Linux x86 (64-bit)
Fedora Core Linux 4
Fedora Core 5 Linux x86 (64-bit)
Mandrake Linux 9.1 (32-bit) & Mandrake Linux 9.2 (32-bit)
Turbo Linux 10 (32-bit)
RHEL3.0 & RHEL 3.0 (32-bit) UPDATE 5

TYAN reserves the right to add support or discontinue support for any OS with or without notice.

Chapter 2: Board Installation

Installation

You are now ready to install your motherboard. The mounting-hole pattern of the Tomcat K8SH S3850 matches the ATX specification. Before continuing with installation, confirm that your chassis supports an ATX motherboard.

How to install our products right.... the first time!

The first thing you should do is read this user's manual. It contains important information that will make configuration and setup much easier. Here are some precautions you should take when installing your motherboard:

- (1) Ground yourself properly before removing your motherboard from the antistatic bag. Unplug the power from your computer power supply and then touch a safely grounded object to release static charge (i.e. power supply case). For the safest conditions, Tyan recommends wearing a static safety wrist strap.
- (2) Hold the motherboard by its edges and do not touch the bottom of the board, or flex the board in any way.
- (3) Avoid touching the motherboard components, IC chips, connectors, memory modules, and leads.
- (4) Place the motherboard on a grounded antistatic surface or on the antistatic bag that the board was shipped in.
- (5) Inspect the board for damage.

The following pages include details on how to install your motherboard into your chassis, as well as installing the processor, memory, disk drives and cables.

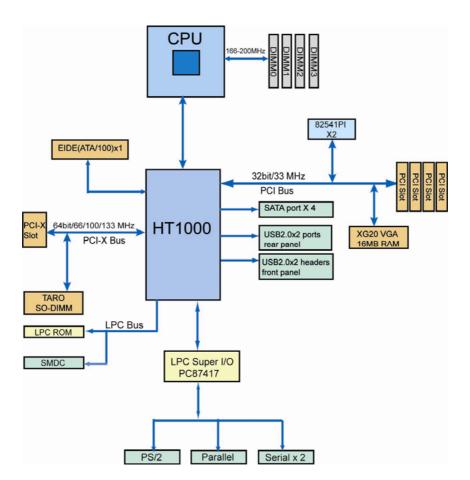
NOTE

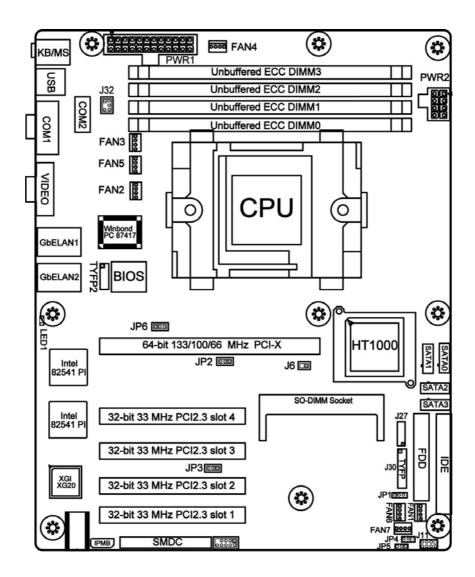
DO NOT APPLY POWER TO THE BOARD IF IT HAS BEEN DAMAGED



This picture is representative of the latest board revision available at the time of publishing. The board you receive may or may not look exactly like the above picture.

The following page includes details on the vital components of this motherboard.





This diagram is representative of the latest board revision available at the time of publishing. The board you receive may not look exactly like the above diagram.

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2.03 - Jumper Settings

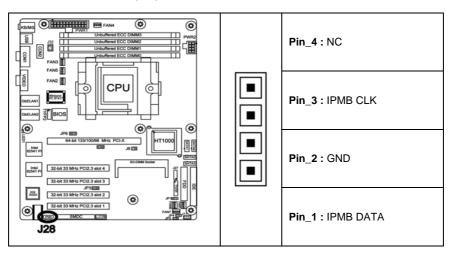
Jumper	Function	Settings
J28	IPMB Pin Header	See Section 2.04
JP4, JP5	ASF 2.0/SMDC Select	See Section 2.05
JP6	Clear CMOS Jumper	See Section 2.06
J14	USB Header	See Section 2.07
J6	PCI-X Bus Frequency	See Section 2.08
J32	LCM Pin Header	See Section 2.09
J30	Front Panel Connector	See Section 2.10
JP2	PCI/PCIX Mode Select	See Section 2.11
J21~J25,	FAN Connectors with speed	See Section 2.12
J33, J34	control	000 000
J27	2x7 Pin Fan Connector	See Section 2.13
J29	SMDC	See Section 2.14

Jumper Legend

OPEN - Jumper OFF	Without jumper cover
CLOSED - Jumper ON	With jumper cover

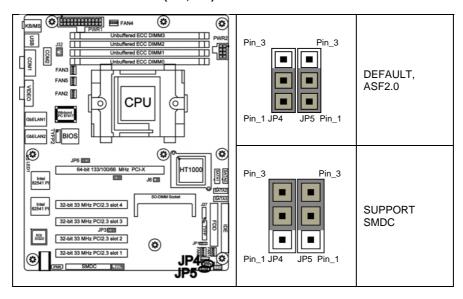
† Pin-1	To indicate the location of pin-1
↑ Pin-1	To indicate the location of pin-1

2.04 - IPMB Pin Header (J28)

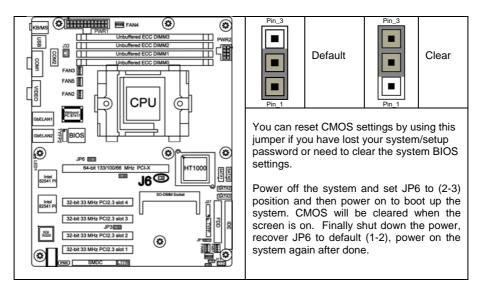


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2.05 - ASF 2.0/SMDC Select (JP4, JP5)

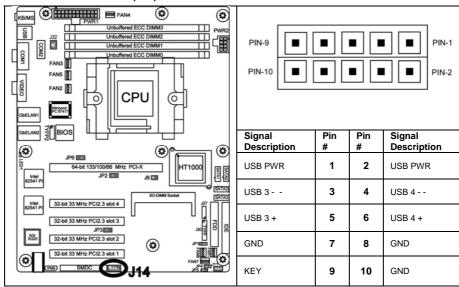


2.06 - Clear CMOS Jumper (JP6)

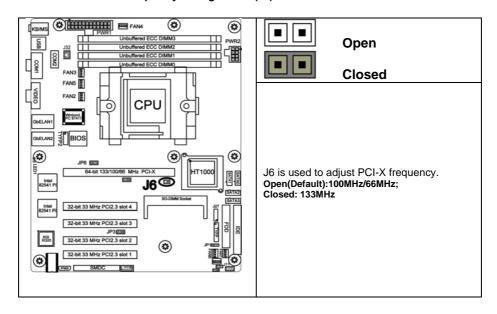


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2.07 - USB2.0 Header (J14)

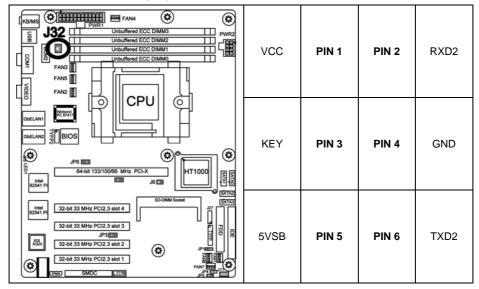


2.08 - PCI-X Bus Frequency Configuration (J6)

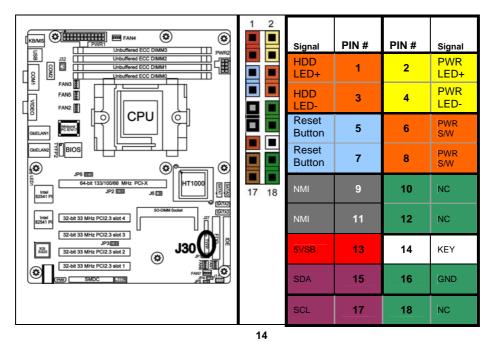


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2.09 - LCM Pin Header (J32)

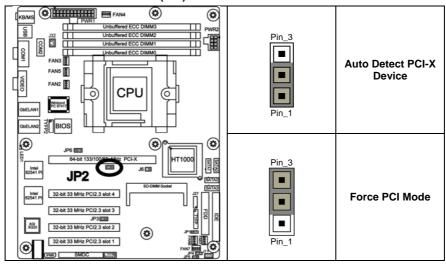


2.10 - Front Panel Connector (J30)

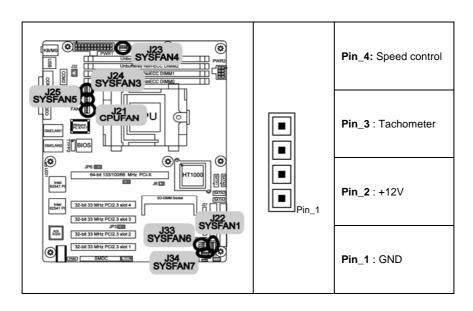


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2.11 - PCI/PCI-X Mode Select (JP2)

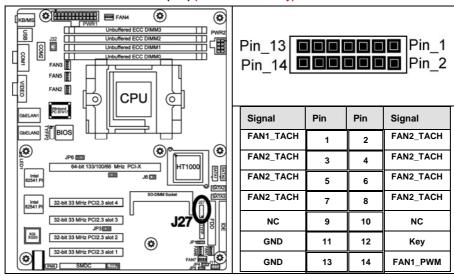


2. 12 - FAN Connectors with speed control (J21~J25, J33, J34)

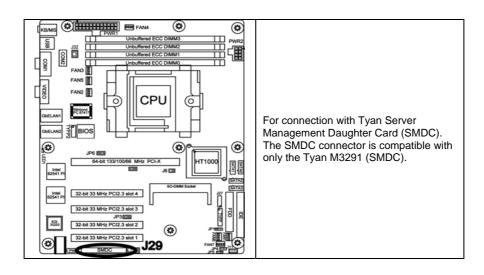


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2.13 - 2x7 Pin Fan Connector (J27) (For Barebone only)



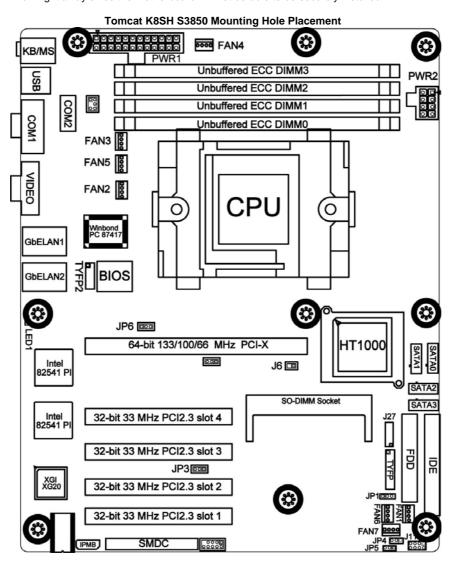
2.14 - SMDC Connector (J29)



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2.15 - Tips on Installing the Motherboard in Chassis

Before installing your motherboard, make sure your chassis has the necessary motherboard support studs installed. These studs are usually metal and are gold in color. Usually, the chassis manufacturer will pre-install the support studs. If you're unsure of stud placement, simply lay the motherboard inside the chassis and align the screw holes of the motherboard to the studs inside the case. If there are any studs missing, you will know right away since the motherboard will not be able to be securely installed.

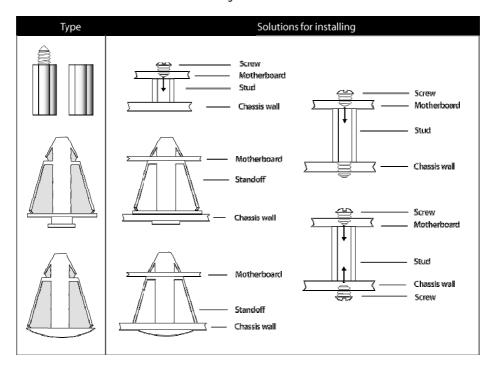


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Some chassis include plastic studs instead of metal. Although the plastic studs are usable, Tyan recommends using metal studs with screws that will fasten the motherboard more securely in place.

Below is a chart detailing what the most common motherboard studs look like and how they should be installed.

Mounting the Motherboard



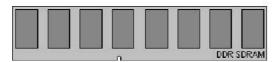
TIP: Use metal studs if possible, as they hold the motherboard into place more securely than plastic standoffs.

2.16 - Installing the Memory

Before attempting to install any memory, make sure that the memory you have is compatible with the motherboard as well as the processor*. A Critical aspect to system building is whether you're using the recommended memory for the motherboard that you have. For compatibility information, please check Tyan's web site at: www.tyan.com

* Not all stepping's of AMD Opteron CPU's support the same type of memory speeds. Consult with AMD for clarification.

The following diagram shows the common types of RAM modules you may encounter depending on your board:



Here are a few key points to note before installing memory into your Tomcat K8SH:

- AMD OpteronTM processors support 64bit (non-interleaved) or 128bit (interleaved) memory configurations
- At least ONE Unbuffered ECC DDR SDRAM module must be installed for the system to turn on and POST (power on self test)
- 128MB, 256MB, 512MB, 1GB and 2GB* Unbuffered ECC PC2100, PC2700, PC3200 DDR SDRAM memory modules are supported
- All installed memory will be automatically detected
- The Tomcat K8SH supports up to 8GB.
- * Not validated at the time of print, subject to change.

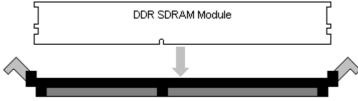
Valid DIMM Configurations

The processor supports 64-bit mode and 128-bit mode configurations of the DIMMs. In 64-bit mode, only DIMMs 1 and 3 can be populated. Possible combinations of DIMMs in 64-bit mode are listed in the table as below. In 128-bit mode, a minimum of two DIMMs is required to create the 128-bit bus; therefore, DIMMs can only be populated in even numbered pairs in slots 1 & 2, and 3 & 4. The following table shows some possible combinations of DIMMs for 128-bit mode. **Not all possible combinations are listed in the table**

DIMM Number	64-Bit Width	128-Bit Width	Bank Interleave
DIMM0	Bank 0	Bank 0, low 64	Bank 0, low 64, even
DIMM1	Not Used	Bank 0, high 64	Bank 0, high 64, even
DIMM2	Bank 1	Bank 1, low 64	Bank 0, low 64, odd
DIMM3	Not Used	Bank 1, high 64	Bank 0, high 64, odd

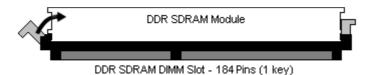
Memory Installation Procedure

When installing memory modules, make sure the modules align properly with the memory socket. There should be keys (small indents) on your memory modules that fit according to the keys in the memory socket. DDR modules and sockets have only one key, which is slightly near the center of the module/socket. The method of installing memory modules is detailed in the following diagrams.



DDR SDRAM DIMM Slot - 184 Pins (1 key)

Once the memory modules are firmly seated in the socket, two clamps on either side will close and secure the module into the socket. Sometimes you may need to close the clamps manually.



To remove the memory module, simply push the clamps outwards until the memory module pops up. Then simply remove the module.

TIP: When installing memory, a module may require a considerable amount of force to seat properly, although this is very rare. To avoid bending and damaging your motherboard, place it on its anti-static bag and onto a flat surface, and then proceed with memory installation.



YOU MUST ALWAYS unplug the power connector to the motherboard before performing system hardware changes, to avoid damaging the board or expansion device.

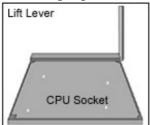
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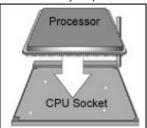
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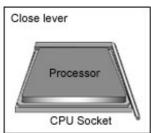
2.17 - Installing the Processor and Heatsink

Your Tomcat K8SH S3850 supports the latest 64-bit processor technologies from AMD. However, only AMD OpteronTM processor are certified and supported with this motherboard. Reference the Tyan website for further details: www.tyan.com

The following diagrams will detail how to install your processor:







The processors you choose to use may not look exactly like the one pictured above, nor will the socket look exactly the same. The diagram is provided as a visual guide to help you install socket processors.

- Lift the lever on the socket until it is approximately 130° or as far back as possible to the socket.
- 2. Align the processor with the socket. There are keys underneath the processor just like on memory modules to ensure that they insert the correct way.
- Seat the processor firmly into the socket by gently pressing down until the processor sits flush with the socket.
- Place the socket lever back down until it snaps into place. 4.
- Your processor is installed.

Take care when installing processor as it has very fragile connector pins below the processor and can bend and break if inserted improperly.

Heatsink Retention Frame and Back Plate Installation

After you are done installing the processor, you should proceed to installing the heatsink. Heatsink will ensure that the processor does not overheat and continues to operate at maximum performance for as long as you own it. Overheated processor may damage the motherboard.

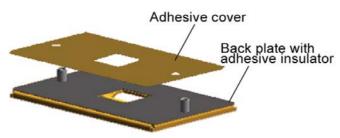
The back plate assembly prevents excessive motherboard flexing in the area near the processor and provides a base for the installation of the heatsink retention frame and heatsink.

Because there are many different types of heatsinks available from many different manufacturers, a lot of them have their own method of installation. For the safest method of installation and information on choosing the appropriate heatsink, please refer to AMD's website at http://www.amd.com.

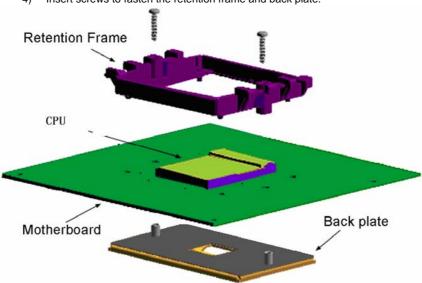
The following diagram will illustrate how to install the most common CPU heatsink retention frame and back plates:

http://www.tyan.com

1) Remove the adhesive cover from the back plate.

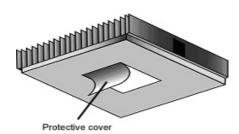


- Align the back plate screw bolts to the holes around processor socket on the back of motherboard.
- Align the heatsink retention frame to the back plate screw bolts on the front of motherboard.
- 4) Insert screws to fasten the retention frame and back plate.



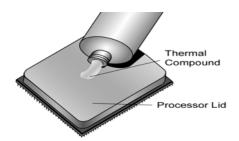
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2.18 -- Thermal Interface Material



There are two types of thermal interface materials designed for use with the AMD Opteron processor.

The most common material comes as a small pad attached to the heatsink at the time of purchase. There should be a protective cover over the material. Take care not to touch this material. Simply remove the protective cover and place the heatsink on the processor.



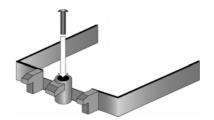
The second type of interface material is usually packaged separately. It is commonly referred to as 'thermal compound'. Simply apply a thin layer on to the CPU lid (applying too much will actually reduce the cooling).



Aways check with the manufacturer of the heatsink & processor to ensure the Thermal Interface material is compatible with the processor & meets the manufacturer's warranty requirements

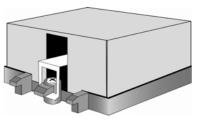
2.19 Heatsink Installation Procedures

Type A: CAM LEVER (TYPE) INSTALLATION

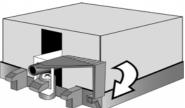


1. After placing backplate and interface material under motherboard place heatsink retention frame on top of motherboard. Align plastic retention bracket screw hole with CPU back-plate standoffs. Tighten screws to secure plastic retention bracket. Repeat for on other side.

DO NOT OVER TIGHTEN.

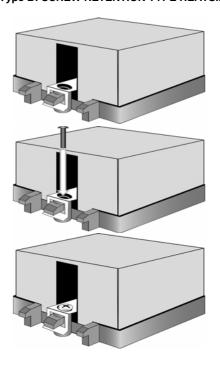


2. After tightening screws secure metal clip to plastic retention bracket center tab. Repeat for on other side of heatsink.



3. After securing metal clip to plastic retention bracket center tab, push down on plastic clip to lock plastic clip to side tab.

Type B: SCREW RETENTION TYPE HEATSINK



- 1. After placing CPU back-plate and adhesive interface material under motherboard, place heatsink retention frame on top of motherboard. Align heatsink retention frame screw hole with backplate assembly standoffs. Place heatsink inside plastic retention bracket. Place metal clip over retention frame tab. Repeat for other side.
- 2. Insert screw through metal clip. BE SURE METAL CLIP IS LOCKED ONTO RETENTION FRAME TAB.
- 3. Tighten screw through metal clip. Repeat on other side. **DO NOT OVER TIGHTEN.**

Finishing Installing the Heatsink

After you finish installing the heatsink onto the processor and socket, attach the end wire of the fan (which should already be attached to the heatsink) to the motherboard. The following diagram illustrates how to connect fans onto the motherboard.



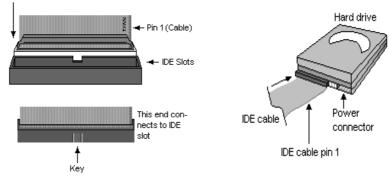
After you're finished installing all the fans you can connect your drives (hard drives, CD-ROM drives, etc.) to your motherboard.

2.20 - Attaching Drive Cables

IDE Drives

Attaching IDE drive cabling is simple. The cable is "keyed" to only allow it to be connected in the correct manner. Tyan motherboards have one on-board IDE channel, and it supporting two drives.

Attaching IDE cables to the IDE connectors is illustrated below:



Simply plug in the BLUE END of the IDE cable into the motherboard IDE connector, and the other end(s) into the drive(s). Each standard IDE cable has three connectors, two of which are closer together. The BLUE connector that is furthest away from the other two is the end that connects to the motherboard. The other two connectors are used to connect to drives.

Note: Always remember to properly set the drive jumpers. If only using one device on a channel, it must be set as Master for the BIOS to detect it.

TIP: Pin 1 on the IDE cable (usually designated by a colored wire) faces the drive's power connector.

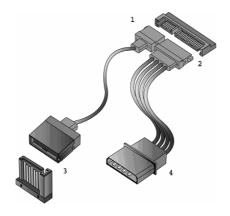
SATA Drivers

The Tomcat K8SH may be also equipped with 4 Serial ATA (SATA) channels. Connections for these drives are also very simple.

There is no need to set Master/Slave jumpers on SATA drives.

Tyan has supplied two SATA cables and one SATA power adapter for boards equipped with SATA" since this is a BOM option. If you are in need of other cables or power adapters please contact your place of purchase.

The following picture illustrates how to connect a SATA drive

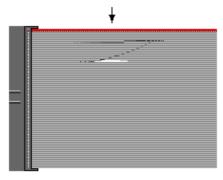


- 1. SATA drive cable connection
- 2. SATA drive power connection
- 3. SATA cable motherboard connector
- 4. SATA drive power adapter

Floppy Drives

Attaching a floppy drive can be done in a similar manner to an IDE drive. See the diagram below for an example of a floppy cable. Most of the current floppy drives on the market require that the cable be installed with the colored stripe positioned next to the power connector. In most cases, there will be a key pin on the cable, which will force proper connection of the cable.

Twist at the end of the ribbon cable



The first floppy drive (commonly denoted as **A**:) is usually attached to the end of the cable with the twist in it. Drive B: is usually connected to the second or third connector in the cable (the second or third connector after you install Drive **A**:).

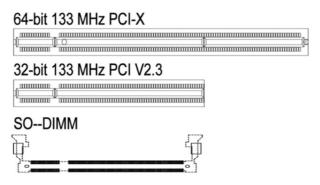
Refer to your floppy drive's installation instructions (if available), or contact your dealer if you are unsure about how to attach the floppy drive(s). Remember, you can only have 2 floppy drives connected at any given time.

Below are some symptoms of incorrectly installed floppy drives. While they are minor and installing them incorrectly doesn't cause severe problems, it may cause your system to freeze or crash when trying to read and/or write to diskettes.

Symptoms of incorrectly installed floppy drives Usually caused by faulty cables, cables put in backwards or a bad floppy drive or motherboard. Try another floppy drive to verify the problem if the cable Drive is not automatically detected is properly installed or try replacing the actual cable. Also check to see if the onboard floppy controller is enabled in the BIOS setup. The cable, floppy drive or motherboard Drive Fail message at bootup may be faulty. Try another drive or cable to verify. Check power cable and cabling. Drive does not power on Maybe a bad power supply or drive cable problem. Usually signifies that the cable on the drive is on backwards, which is a Drive activity light is constantly on common issue. Reverse the cable at the floppy drive end and try again.

2.21 - Installing Add-In Cards

Before installing add-in cards, it's helpful to know if they are fully compatible with your motherboard. For this reason, we've provided the diagrams below, showing the most common slots that may appear on your motherboard. Not all of the slots shown will necessarily appear on your motherboard, however, there will be combinations of what you see here.



Simply find the appropriate slot for your add-in card and insert the card firmly. Do not force any add-in cards (or anything else) into any slots if they won't seat in place. It's

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better to try another slot or return the faulty card rather than damaging both the motherboard and the add-in card.

TIP: It's good practice to install add-in cards in a staggered manner, rather than directly adjacent to each other. This allows air to more easily circulate within the chassis, providing improved cooling for all installed devices.



YOU MUST ALWAYS unplug the power connector to the motherboard before performing system hardware changes, to avoid damaging the board or expansion device.

2.22 - Installing Optional SO-DIMM Modules

Your Tiger K8SH S3850 motherboard is equipped with an optional proprietary SO-DIMM connector. The SO-DIMM connector can be used for expansion cards to provide such features as, additional SAS/SATA or SCSI support. For details of available expansions cards, visit the TYAN website at http://www.tyan.com. To install a SO-DIMM expansion card:

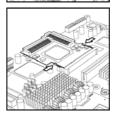
1. Open the spring levers as shown.



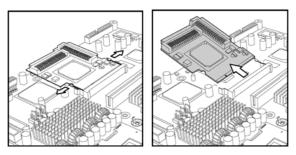
Insert the SO-DIMM card as shown, making sure that the card is the right way up. The card will fit in only one way and the screw holes in the card should line up exactly with the mounting posts on the motherboard.



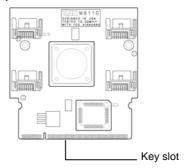
- Push the SO-DIMM card down into place and make sure the spring levers click into place as shown.
- Screw the board into place using one or two screws as required.



28 http://www.tyan.com Removal of a SO-DIMM card is a reversal of the installation procedure. Push out the spring levers as shown and pull the card out of the socket.

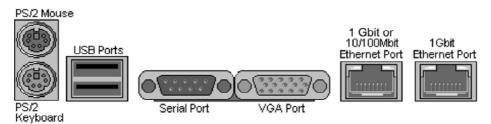


The SO-DIMM expansion cards will fit in the slot only one way. Make sure that you align the slot in the card with the key in the card slot.



2.23 - Connecting External Devices

Connecting external devices to the motherboard is an easy task. The standard devices you should expect to plug into the motherboard are keyboards, mice, and printer cables. The following diagram will detail the ATX port stack for the following board:

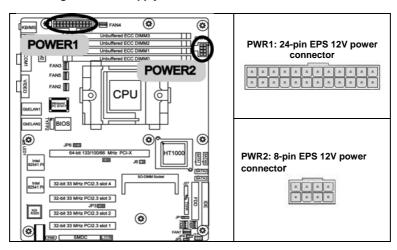


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Besides being used primarily to connect printers, the Printer Port is also used for devices such as Zip drive, some external CD-RW drives and or other external devices. More on the uncommon side these days are the Serial Ports. They were primarily used to connect external modems, but most modems today are using USB or are installed internally.

TIP: While the ports have been created to accept connectors in only one direction, make sure to be careful when inserting connectors. At times, attaching connectors in the incorrect orientation can damage, bend and or break the pins.

2.24 - Installing the Power Supply



We suggest using a **400W** or higher power supply; this is of course dependent on how many devices you attach. A **400W** is sufficient for systems without many devices (i.e. 1 hard drive, 1 optical drive, and 1 or 2 expansion cards) however a higher wattage solution may be needed if the system is fully loaded. Look to the www.tyan.com website for further information.

NOTE: The S3850 Tomcat K8SH peripheral drive power connector must be independent of any other devices. A device such as a DVD/CD-ROM drive, hard drive, or any other devices cannot be attached onto the same power line. If connected, system stability is compromised.

2.25 - Finishing Up

Congratulations on making it this far! You're finished setting up the hardware aspect of your computer. Before closing up your chassis, make sure that all cables and wires are connected properly, especially IDE cables and most importantly, jumpers. You may have difficulty powering on your system if the motherboard jumpers are not set correctly.

In the rare circumstance that you have experienced difficulty, you can find help by asking your vendor for assistance. If they are not available for assistance, please find setup information and documentation online at our website or by **calling your vendor's support line.**

Chapter 3: BIOS

3.1 - BIOS Setup Utility

With the BIOS setup utility, you can modify BIOS settings and control the special features of your computer. The setup utility uses a number of menus for making changes and turning the special features on or off.

NOTE

All menus are based on a typical system. The actual menus displayed on your screen may be different and depend on the hardware and features installed in your computer.

To start the BIOS setup utility:

- a. Turn on or reboot your system
- b. Press during POST (F4 on remote console) to start BIOS setup utility

	BIOS Setup Utility					
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit
System Ove	System Overview					R], [TAB] ⁻ AB] to
AMIBIOS					select a fiel	d
	MM/DD/YY					•
Processor Type : Speed : Count : System Men Size : System Time	Processor Type : AMD Opteron(tm) Model xxx Speed : xxxx MHz Count : x					t Screen Item ge Option ral Help

To select an item

Use the left/right ($\leftarrow \rightarrow$) arrow keys to make a selection.

To display a sub-menu (A pointer " ▶ " marks all sub menus)

Use the arrow keys to move the cursor to the sub menu you want. Then press <Enter>.

3.2 - BIOS Menu Bar

The menu bar at the top of the windows lists these selections:

Main	To configure basic system setups
Advanced	To configure the advanced chipset features
PCI/PnP	To configure legacy Plug & Play or PCI settings
Boot	To configure system boot order
Security	To configure user and supervisor passwords
Chipset	To configure chipset management features
Exit	To exit setup utility

NOTE

Options written in **bold type** represent the BIOS setup default

3.3 - BIOS Legend Bar

The chart describes the legend keys and their alternates:

Key	Function
<f1></f1>	General help window
<esc></esc>	Exit current menu
← → arrow keys	Select a different menu
↑ or ↓ arrow keys	Move cursor up/down
<tab> or <shift-tab></shift-tab></tab>	Cycle cursor up/down
<home> or <end></end></home>	Move cursor to top/bottom of the window
<pgup> or <pgdn></pgdn></pgup>	Move cursor to next/previous page
<->	Select the previous value/setting of the field
<+>	Select the next value/setting of the field
<f8></f8>	Load Fail Safe default configuration values of the menu
<f9></f9>	Load the Optimal default configuration values of the
	menu
<f10></f10>	Save and exit
<enter></enter>	Execute command or select submenu

3.4 - BIOS Main Menu

The Main BIOS Menu is the first screen that you can navigate. The Main BIOS setup menu screen has two main frames. The left frame displays all the options that can be configured. "Grayed-out" options cannot be configured, options in blue can be changed.

The right frame displays the key legend. Above the key legend is an area reserved for a text message. When an option is selected in the left frame, it is highlighted in white. Often, a text message will accompany it.

	BIOS Setup Utility						
Main	Advanced	PCI/PnP	Boot	Security	/ Chipset	Exit	
System Overview					Use [ENTER [SHIFT-TAB]		
AMIBIOS Version : 0 Build Date : r ID : >					field Use [+] or [-] configure sys		
Processor Type : A Speed : Count :		tm) Model xxx	хх		← → Select t		
System Mem Size ::	xxxx MB		,		Enter Go to S F1 Genera F10 Save a	Sub Screen Il Help	
System Time System Date		[HH:MM:SS [DD MM/DD	-		ESC Exit		

Feature	Option	Description
Main		
System Time	HH:MM:SS	Set the system time
System Date	MM : DD : YYYY	Set the system date

3.5 - BIOS Advanced Menu

You can select any of the items in the left frame of the screen, such as Super I/O Configuration, to go to the sub menu for that item. You can display an Advanced BIOS Setup option by highlighting it using the <Arrow> keys. All Advanced BIOS Setup options are described in this section. The Advanced BIOS Setup screen is shown below. The sub menus are described on the following pages.

ı							
		BIOS	Setup Uti	lity			
Main	Advanced	PCI/PnP	Boot	Securi	ty Ch	nipset	Exit
Advanced S	Settings						
					Option	s for CP	U
WARING: Se	etting wrong va	lues in below	v section:	s may			
С	ause system to	malfunction	١.				
	•						
▶ CPU Conf	iguration				← → §	Select So	creen
▶ IDE Config	guration				↑↓S	elect Ite	m
▶ Floppy Co	nfiguration				Enter	Go to S	Sub Screen
▶ Super IO (Configuration					General	
▶ S-ATA Co	nfiguration					Save and	•
▶ ACPI Con	figuration				ESC E	Exit	
▶ Event Log	Configuration						
▶ Hyper Tra	nsport Configu	ration					
▶ Hardware	Health Configu	ıration					
▶ MPS Conf							
► AMD Cool 'N Quiet Configuration							
▶ Remote Access Configuration							
▶ USB Configuration							
	PCI Slots Confi	guration					
		-					
1							

Feature	Option Description			
Advanced Settings				
CPU Configuration	Menu Item Options for CPU			
IDE Configuration	Menu Item Configure the IDE device(s)			
Floppy Configuration	Menu Item Configure the Floppy drive(s)			
Super IO Configuration	Menu Item Configures Super IO Chipset Nat417			
S-ATA Configuration	Menu Item Configure ServerWorks HT1000 S-ATA			
ACPI Configuration	Menu Item Section for Advanced ACPI Configuration			
Event Log Configuration	Menu Item Mark as read, Clear or View Event Log statistics			
Hyper Transport Configuration	Menu Item Configure HT links			
Hardware Health Configuration	Menu Item	Configure/monitor the Hardware Health		
MPS Configuration	Menu Item	Configure the Multi-Processor Table		
AMD Cool 'N Quiet Configuration	Menu Item	Configure AMD PowerNow support		
Remote Access Configuration	Menu Item Configure Remote Access			
USB Configuration	Menu Item	Configure the USB support		
Device & PCI Slots Configuration	Menu Item	Onboard Devices and PCI Add- On Cards Enabled/Disabled		

3.5.1 CPU Configuration Sub-MenuYou can use this screen to view CPU Configuration Menu. Use the up and down arrow $(\uparrow \land \downarrow)$ keys to select an item. Use the Plus and Minus $(+ \land \land)$ keys to change the value of the selected option. The settings are described on the following pages.

BIOS Setup Utility				
Main Advanced	PCI/PnP	Boot	Security	Chipset Exit
CPU Configuration				This option should remain disabled for
Module Version : XX.XX Physical Count : X Logical Count : X				normal operation. The driver developer may disable it for testing purpose.
Dual Core AMD Opteron (tm Revision: XX Cache L1: XXXKB Cache L2: XXXXKB Speed: XXXXMHz Current FSB Multiplier: Maximum FSB Multiplier: Able to change Freq.: uCode Patch Level: GART Error Reporting MTRR Mapping	XXX XXX Yes XXXX			← → Select Screen † ↓ Select Item +/- Change Option F1 General Help F10 Save and Exit ESC Exit

Feature	Option	Description			
CPU Configuration					
Module Version Physical Count Logical Count	Read only	Displays information about CPU			
Revision					
Cache L1		Displays information about CPU			
Cache L2					
Speed	Read only				
Current FSB Multiplier	ixeau only				
Maximum FSB Multiplier					
Able to change Freq.					
uCode Patch Level					
GART Error Reporting	Disabled	This option should remain disabled for normal operation. The driver developer may enable it for the purpose of testing.			
	Enabled				

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Feature	Option	Description
CPU Configuration		
MTPR Manning	Continuous	This option determines the method used for programming CPU MTRRs when 4GB or more of memory is preset. Discrete leaves
MTRR Mapping	Discrete	the PCI hole below the 4GB boundary undescribed. Continuous explicitly describes the PCI hole as non-cacheable.

3.5.2– IDE Configuration Sub-Menu
You can use this screen to select options for the IDE Configuration Settings. Use the up and down <Arrow> keys to select an item. Use the <Plus> and <Minus> keys to change the value of the selected option.

Feature	Option	Description
IDE Configuration		
Primary IDE Master/Slave	Auto XXXX Not Installed Enabled	While entering Setup, BIOS auto detects the presence of IDE devices. This displays the status of auto detection of IDE devices.
IDE Detect Time Out (Sec)	0~35 (at 5 interval)	Selects the time out value for detecting ATA/ATAPI device(s).

		BIOS	Setup Uti	lity		
Main	Advanced	PCI/PnP	Boot	Security	/ Chipset	Exit
IDE Configura	ation				[Disabled] : d integrated ID	E controller.
▶ Primary IDE▶ Primary IDE			[xxxx]		[Primary] : en the primary I	,
IDE Detect Time Out (Sec) :		[xx]		← → Select Screen ↑ ↓ Select Item		
					+/- Change F1 Genera F10 Save an ESC Exit	l Help

3.5.2.1 - Primary/Secondary IDE Master/Slave Sub-Menu

3.5.2.1 - Primary/Secondary IDE Master/Slave Sub-Menu							
		BIOS	Setup Util	ity			
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit	
Primary IDE	Master						
Primary IDE Master Device: Not Detected Type LBA /Large Mode Block (Multi-Sector Transfer) PIO Mode			[Auto [Auto [Auto	o] o]	Tab Select	Item ge Option Field ral Help	
DMA Mode S.M.A.R.T.			[Auto	0]			
32 Bit Data Tra	ansfer		[Ena	ıbled]			

Feature	Option	Description
Configure Nat417 Super IO C	Chipset	
Туре	Auto Not Installed CD/DVD ARMD	Selects the type of device connected to the system.
LBA/Large Mode	Auto	Auto: Enabled LBA Mode if the device supports it and the device is not already formatted with LBA
	Disabled	Mode disabled. Disabled: Disabled LBA Mode.
Block (Multi-Sector Transfer)	Auto	Disabled: The Data transfer from and to the device occurs one sector at a time.
Block (Multi Sector Transfer)	Disabled	Auto: The Data transfer from and to the device occurs multiple sectors at a time if the device supports it.
PIO Mode	Auto	Selects the PIO Mode. Select Auto to enhance hard disk performance
1 10 Wode	0~4 (at 1 interval)	by optimizing the hard disk timing.
DMA Mode	Auto	Selects DMA Mode. Auto: Auto detected.
	Auto	S.M.A.R.T (Self-Monitoring Analysis
S.M.A.R.T.	Disabled	and Reporting Technology) is a utility that monitors your disk status
	Enabled	to predict hard disk failure.
32Bit Data Transfer	Enabled Disabled	Enables 32-bit to maximize the IDE hard disk data transfer rate.

3.5.3 - Floppy Configuration Sub-Menu

You can use this screen to specify options for the Floppy Configuration Settings. Use the up and down <Arrow> keys to select an item. Use the <Plus> and <Minus> keys to change the value of the selected option. The settings are described on the following pages.

BIOS Setup Utility								
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit		
Floppy Con	figuration		Select the t	type of e connected				
Flanny A		[4 44 M	D 24/2"]		to the syste			
Floppy A Floppy B		[1.44 M	B 31/2"] ed]		← → Select ↑ ↓ Select +/- Chang F1 Gene F10 Save ESC Exit	t Item e Option ral Help		

Feature	Option	Description
Floppy Configuration		
	Disabled	
	360 KB 51/4"	Selects the type of floppy drive
Floppy A	1.2 MB 51/4"	connected to the system.
Floppy B	720 KB 31/2"	
	1.44 MB 31/2"	
	2.88 MB 31/2"	

3.5.4 - Super IO Configuration Sub-Menu

You can use this screen to select options for the Super I/O settings. Use the up and down arrow (\uparrow/ψ) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option

	BIOS Setup Utility								
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit			
		O Chipset	[Enab [3F8/II [2F8/II	RQ4]	or disable Controller. ← → Sele ↑ ↓ Selec +/- Char	ct Screen et Item nge Option eral Help			

Feature	Option	Description
Configure Nat417 Super IO C	Chipset	
Onboard Floppy Controller	Enabled	Allows BIOS to enable or disable the
Criboard Floppy Controller	Disabled	floppy controller.
	3F8/IRQ4	
Serial Port1 Address	3E8/IRQ4	Allows BIOS to select Serial Port1
Senai Porti Address	2E8/IRQ3	Base Addresses.
	Disabled	
	2F8/IRQ3	
Serial Port2 Address	3E8/IRQ4	Allows BIOS to select Serial Part2
	2E8/IRQ3	Base Addresses.
	Disabled	

3.5.5 S-ATA Configuration Sub-MenuYou can use this screen to view S-ATA Configuration Menu. Use the up and down arrow (\uparrow / \downarrow) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option. The settings are described on the following pages.

	BIOS Setup Utility								
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit			
Configure S	ServerWorks				Enable HT1000 S-ATA.				
HT1000 S-ATA S-ATA Mode INT13 Support		į	Enabled] [P-ATA] [Enabled]			Item ge Option ral Help			

Feature	Option	Description	
Configure ServerWorks			
HT1000 S-ATA	Enabled	Allows user to enable or disable	
1111000 3-ATA	Disabled	HT1000 S-ATA controller.	
S-ATA Mode	P-ATA	Sets S-ATA mode as P-ATA	
3-ATA Mode	S-ATA	emulation or native S-ATA.	
INIT12 Cumpart	Enabled	Enchlos or dischlos INIT42 ournout	
INT13 Support	Disabled	Enables or disables INT13 suppor	

3.5.6 –ACPI Configuration Sub-MenuUse this screen to select options for ACPI. Use the up and down arrow (\uparrow/ψ) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option. A description of the selected item appears on the right side of the screen. The settings are described on this page. The screen is shown below.

BIOS Setup Utility								
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit		
Advanced A ACPI Version ACPI APIC S ACPI SRAT AMI OEMB to Headless mo	Support Table able]]]]	ACPI v2.0 Enabled] Enabled] Enabled] Disabled])]	Enable RSD to 64-bit Fixe Description ↑ ACPI version ↑ ← → Select ↑ ↓ Select I	ed System Fables. Di has some Screen tem e Option al Help		

Feature	Option	Description	
Advanced ACPI Configuration			
	ACPI v3.0	Set this value to allow or prevent	
ACPI Version Features	ACPI v2.0	the system to be complaint with	
	ACPI v1.0	the ACPI 2.0 specification.	
ACPI APIC Support	Enabled	This option allows you to define whether or not to enable ACPI	
ACFI AFIC Support	Disabled	management features.	
ACPI SRAT Table	Enabled	Enable or disable the building of	
ACFISICAT Table	Disabled	ACPI SRAT Table.	
AMI OEMB table	Enabled	Set this value to allow the ACPI BIOS to add a pointer to an OEMB table in the Root System Description Table (RSDT) table.	
	Disabled	Note: OEMB table is used to pass POST data to the AMI code during ACPI O/S operations.	
Headless mode	Enabled	Enable or disable Headless	
Ticadicas mode	Disabled	operation mode through ACPI.	

3.5.7 - Event Logging details Sub-Menu

You can use this screen to view the Event Log Control Menu. This logs system events (such as CMOS clear, ECC memory errors, etc) and writes the log into NVRAM. Use the up and down arrow (\uparrow/\downarrow) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option. The settings are described on the following pages.

	BIOS Setup Utility							
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit		
Event Logging details				View all unre				
View Event I Mark All Eve Clear Event Event Log S	ents as Read Log				← → Select I ↑ ↓ Select I +/- Chang Enter Go to S F1 Genera F10 Save a ESC Exit	tem e Option Sub Screen al Help		

Feature	Option	Description
Event Logging details		
View Event Log		Views all unread events on the Event Log.
Mark All Events as Read	OK Cancel	Marks all unread events as read.
Clear Event Log	OK Cancel	Erases all of events.
Event Log Statistics		View details on the count of total unread events. Other stats include size occupied and size free. (in terms of event units)

3.5.8 - Hyper Transport Configuration Sub-Menu

You can use this screen to view the Hyper Transport Configuration Menu. Use the Plus and Minus (+/-) keys to change the value of the selected option. The settings are described on the following pages.

		BIOS	Setup Ut	ility		
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit
Hyper Trans	sport Configu	ration		·	The Hyper	at this
CPU: HT1000 HT Link Speed CPU: HT1000 HT Link Width			[Auto] [Auto]		speed if it is slower than or equal to the system clock and the board is capable.	
						t Item age Option eral Help

Feature	Option	Description
Hyper Transport Configuratio	n	
	Auto	The Hyper Transport link will
CPU: HT1000 HT Link Speed	200MHz	run at this speed if it is slower
	400MHz	than or equal to the system
	600MHz	clock and the board is capable.
	800MHz	
	Auto	The Hyper Transport link will
CPU: HT1000 HT Link Width	2 Bit	run at this width.
	4 Bit	
	8 Bit	

3.5.9 – Hardware Health Configuration Sub-Menu You can use this screen to view the Hardware Health Configuration Settings. Use the up and down arrow (\uparrow / \downarrow) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option. The settings are described on the following pages.

BIOS Setup Utility								
Main Advanced	PCI/PnP	Boot	Security	Chipset	Exit			
Hardware Health Configurat	Enables Hardware Health Monitoring							
H/W Health Function FAN Select FAN Power Control PWM Minimal Duty Cycle	Device.							
Hardware Health Event Mon	Hardware Health Event Monitoring							
▶ Mainboard Voltages Report				← → Select ↑ ↓ Select				
CPU Temperature VRM Temperature System Temperature FAN1 To FAN4 Speed Repo FAN5 To FAN7 Speed Repo	:xx C/ xxx :xx C/ xxx :xx C/ xxx	F	Tab Select	al Help				

Feature	Option	Description
Hardware Health Conf	iguration	
H/W Health Function	Enabled	Enables Hardware Health Monitoring Device.
n/w nealth runction	Disabled	
FAN Select	4Pin FAN	Selects the FAN type.
FAIN Select	3Pin FAN	
FAN Power Control	Enabled	FAN power duty cycle is auto dynamic programmed in selected temperature range. Disabled: Fan Power On. Enabled: Fan Power Duty Cycle=30%(40°C)-
PAIN Fower Control	Disabled	100%(60°C), see CPU temperature
PWM Minimal Duty Cycle	50% Duty Cycle	Duty Cycle control range: 50%-100% 40%-100%
	40% Duty Cycle	30%-100% 0% -100%

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Feature	Option	Description
Hardware Health Conf	iguration	
	30% Duty Cycle	
	0% Duty Cycle	

Feature	Option	Description
Hardware Health Event Monit	toring	
Mainboard Voltages Report	Menu Item	Displays Voltage for CPU, memory, & other devices.
CPU Temperature		Displays CPU Temperature and FAN Speed.
VRM Temperature	read only	and this operation
System Temperature		
FAN1 To FAN4 Speed Report	Menu Item	Displays FAN1 To FAN4 Speed.
FAN5 To FAN7 Speed Report	Menu Item	Displays FAN5 To FAN7 Speed.

3.5.9.1 - Mainboard Voltages Report Sub-Menu

0.0.0.	mambea									
	BIOS Setup Utility									
	Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit			
CPU Vo CPU Vo +5 V +12 V	dimm	ard Voltages E	vent Monito	: x.x : x.x : x.x		+/- Cha Tab Sele F1 Ger	neral Help ve and Exit			

3.5.9.2 - FAN1 To FAN4 Speed Report Sub-Menu

		BIOS S	Setup Util	ity		
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit
Board F FAN1 Speed FAN2 Speed FAN3 Speed FAN4 Speed	an1 To Fan4	Speed Mon	XXXX	RPM RPM RPM RPM	↑ ↓ Sele +/- Cha Tab Sele F1 Ger	neral Help re and Exit

3.5.9.3 - FAN5 To FAN7 Speed Report Sub-Menu

BIOS Setup Utility								
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit		
Board	Fan5 To Fan7	7 Speed Mon	itoring_		↑ ↓ Sele	ect Screen oct Item ange Option		
FAN5 Speed FAN6 Speed FAN7 Speed			XXXX	RPM RPM RPM	Tab Sele F1 Ger	ect Field neral Help re and Exit		

3.5.10 MPS Configuration Sub-Menu You can use this screen to select MPS revision. Use the up and down arrow (\uparrow/\downarrow) keys to select an item. The settings are described on the following pages.

BIOS Setup Utility							
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit	
MPS Configu		[1.4]			Select MF ← → Sele ↑ ↓ Sele +/- Cha F1 Ger	PS Revision. ect Screen ct Item inge Option ieral Help e and Exit	

Feature	Option	Description		
MPS Configuration				
MDC Davision	1.1	Allows user to select MPS revision.		
MPS Revision	1.4	Allows user to select MPS revision.		

3.5.11 AMD PowerNow Configuration Sub-Menu

You can use this screen to enable AMD PowerNOw support. Use the up and down arrow (\uparrow/\downarrow) keys to select an item. The settings are described on the following pages.

	BIOS Setup Utility							
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit		
AMD Power	Now Configu	Enabled/Di PowerNow						
PowerNow		[Disabl	ed]			t Item ge Option ral Help		

Feature	Option	Description			
AMD PowerNow Configuration					
David	Enabled	Enabled/Disabled PowerNow			
PowerNow	Disabled	Enabled/Disabled PowerNow			

3.5.12 – Remote Access Configuration Sub-MenuYou can use this screen to view the Remote Access Configuration Menu. This feature allows access to the Server remotely via serial port. Use the up and down arrow (\uparrow / \lor) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option. The settings are described on the following pages.

Blo Main Advanced PCI/Pn	OS Setup Utility P Boot Security	Chipset Exit
Configure Remote Access type an	Select remote access type.	
Remote Access Serial port number Base Address, IRQ Serial port Mode Flow Control Redirection After BIOS POST Terminal Type VT-UTF8 Combo Key Support Sredir Memory Display Delay	→ Select Screen ↑ ↓ Select Item +/- Change Field F1 General Help F10 Save and Exit ESC Exit	

Feature	Option	Description	
Configure Remote Access	type and paramet	ers	
Remote Access	Enabled	Enables remote access to system through serial port.	
	Disabled	tinough sonai port.	
Serial port number	COM1	Selects Serial Port for console redirection. Make sure the	
Serial port number	COM2	selected port is enabled.	
Base Address, IRQ	Read only	Shows the IRQ of the selected Serial Port.	
	115200 8,n,1	Selects Serial Port settings.	
	57600 8,n,1		
Serial port Mode	38400, 8,n,1		
	19200 8,n,1		
	09600 8,n,1		

Feature	Option	Description		
Configure Remote Access	type and paramet	ers		
	None	Selects Flow Control for console		
Flow Control	Hardware	redirection.		
	Software			
	Disabled	Disable: Turns off the redirection after POST		
		Boot Loader:		
Redirection After BIOS POST	Boot Loader	Redirection is active during POST and during Boot Loader.		
		Always: Redirection is always active.		
	Always	Some OSs may not work if set to		
	.,.	Always>		
	ANSI	Selects the target terminal type.		
Terminal Type	VT100			
	VT-UTF8			
VT-UTF8 Combo Key	Disabled	Enables VT-UTF8 Combination key Support for ANSI/VT100		
Support	Enabled	terminals.		
Sredir Memory Display Delay	No Delay	This file allows user to select the delay in seconds to display		
	Delay 1 sec	memory information.		
	Delay 2 sec			
	Delay 4 sec			

3.5.13 - USB Configuration Sub-Menu

You can use this screen to view the USB Configuration Menu. Use the up and down arrow (\uparrow/\downarrow) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option. The settings are described on the following pages.

	BIOS Setup Utility							
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit		
USB Config	uration				Enables US controllers.	SB host		
Module Vers	ion – X.XX.X->	⟨X.Χ			← → Select Screen			
USB Devices Enabled: None					↑ ↓ Select Item +/- Change Option F1 General Help F10 Save and Exit			
Legacy USB BIOS EHCI I		[Enal	bled] bled]		ESC Exit	anu EXII		

Feature	Option	Description
USB Configuration		
Legacy USB Support	Disabled	Enables support for legacy USB.
Legacy OOB Support	Enabled	
BIOS EHCI Hand-Off	Enabled	This is a work around for OSes without EHCI hand-off support.
BIOS EFICITIANG-ON	Disabled	The EHCI ownership change should claim by EHCI driver.

3.5.14 Device & PCI Slots Configuration Sub-MenuYou can use this screen to enable the onboard devices and PCI slots. Use the up and down arrow (\uparrow / \downarrow) keys to select an item. The settings are described on the following pages.

Main Adva		Setup Uti Boot	lity Security	Chipset	Exit
Onboard Device ar	Enabled Disabled				
Onboard LAN1 Devi Onboard LAN2 Onboard LAN2 Devi Onboard LAN2	OP-ROM ce	[Enabled [Disabled [Enabled [Disabled	d] d]		t Item ige Option eral Help

Feature	Option	Description				
MPS Configuration	MPS Configuration					
Onboard LAN1 Device	Disabled	Enabled/Disabled LAN controller				
Onboard LAN2 Device	Enabled	Enabled/disabled Lain controller				
Onboard LAN1 OP-ROM	Disabled	Executed LAN OPROM or not				
Onboard LAN2 OP-ROM	Enabled	Executed EAIN OF NOW OF HOL				

3.6 -BIOS PCI/PnP Menu

You can use this screen to view PnP (Plug & Play) BIOS Configuration Menu. This menu allows the user to configure how the BIOS assigns resources & resolves conflicts. Use the up and down arrow (\uparrow/\downarrow) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option. The settings are described on the following pages.

		BIOS S	Setup Uti	litv		
Main	Advanced	PCI/PnP	Boot	Security	y Chipset	Exit
Advanced I	PCI/PnP Setti	ngs			•	
					Clear NVRAM	l during
WARING: Se	etting wrong va	alues in belov	v sections	s may	System Boot.	
cause syster	n to malfunction	on.		-		
Clear NVRA	M				← → Select S	Screen
Plug & Play	O/S		[No]		↑ ↓ Select Ite	em
PCI Latency	Timer		[Yes]		+/- Change	Option
Allocate IRQ	to PCI VGA		[64]		F1 General	
Palette Snoo			[Yes]		F10 Save an	id Exit
PCI IDE Bus	Master		[Disable	-	ESC Exit	
			[Disable	ed]		

Feature	Option	Description
Advanced PCI/PnP Settings		
Clear NVRAM	No Yes	Clears NVRAM during system Boot.
Plug & Play OS	Yes	No: lets the BIOS configure all the devices in the system. Yes: lets the operating system configure Plug and Play (PnP)
Thag at hay oo	No	devices not required for boot if your system has a Plug and Play operating system.
	32	This setting controls how many
	64	PCI clocks each PCI device can hold the bus before another PCI
	96	device takes over. When set to
PCI Latency Timer	128	higher values, every PCI device
1 Ci Latericy Times	160	can conduct transactions for a
	192	longer time and thus improve the effective PCI bandwidth.
	224	Values in units of PCI clocks for
	248	PCI device latency timer register.
Allocate IRQ to PCI VGA	Yes	Yes: assigns IRQ to PCI VGA card if card requests IRQ.
Allocate in Q to 1 of Von	No	ii dara reguesto irva.
Delette Speening	Disabled	This is the default setting and should not be changed unless the VGA card manufacturer requires Palette Snooping to be Enabled.
Palette Snooping	Enabled	Enabled: informs the PCI devices that an ISA graphics device is installed in the system so the card will function correctly.
	Disabled	Enabled: BIOS uses PCI bus
PCI IDE BusMaster	Enabled	mastering for reading / writing to
	Reserved	IDE drives.

3.7 - BIOS Boot Menu

You can display Boot Setup option by highlighting it using the Arrow (\uparrow / ψ) keys and pressing Enter. The settings are described on the following pages.

	BIOS Setup Utility						
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit	
Boot Setting	js <u> </u>				Configures s during Syste	J	
▶ Boot Settings Configuration					← → Select		
Boot Device PriorityRemovable Drives				Enter Go to S F1 Genera F10 Save a	al Help		
					ESC Exit	-	

3.7.1 - Boot Settings Configuration Sub-Menu

Use this screen to select options for the Boot Settings Configuration. Use the up and down arrow (\uparrow / \downarrow) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option.

	BIOS Setup Utility							
Main A	Advanced	PCI/PnP	Boot	Security	Chipset	Exit		
Quick Boot Quiet Boot Add On ROM Di Boot up Num-Lo PS/2 Mouse Sup Wait for 'F1' if Ei Hit 'DEL' Messay Interrupt 19 Cap	isplay Mode ock pport error age Display	1] 7] 7] 9] 9] 9]	Disabled] Disabled] Force BIOS Dn] Enabled] Enabled] Enabled] Enabled] Disabled]		Allows BIOS certain tests booting. This decrease the needed to be system. ← → Select to Select	while s will s will s will s time sot the screen tem s Option al Help		

Feature	Option	Description
Boot Settings Configuration	on	
Quick Boot	Enabled	This option allows user bypass BIOS
Quick Boot	Disabled	self test during POST.
Quiet Boot	Disabled	Disabled: displays normal POST messages.
Quiet Boot	Enabled	Enabled: displays OEM log instead of POST messages.
Add On ROM Display	Force BIOS	Allows user to force BIOS/Option ROM of add-on cards to be displayed during
Mode	Keep Current	quiet boot.
Boot up Num-Lock	On Off	Selects Power-on state for Numlock.
	Enabled	
PS/2 Mouse Support	Disabled	Selects support for PS/2 Mouse.
	Auto	
Wait for 'F1' If Error	Enabled	Waits for F1 key to be present if error
Walt for 1 1 II Elloi	Disabled	occurs.
Hit 'DEL' Message Display	Enabled	Displays "Press DEL to run Setup" in
Till DEL Message Display	Disabled	POST.
Interrupt 19 Capture	Disabled	Enabled: allows option ROMs to trap
monupi 13 Oapiulo	Enabled	interrupt 19.

3.7.2 – Boot Device Priority Sub-Menu
Use this screen to select options for the Boot Device Priority. Use the up and down arrow $(\uparrow \land \lor)$ keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option.

		BIOS	Setup Uti	lity		
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit
Boot Device	Priority				Specifies sequence	from the
1st Boot Device 2nd Boot Device 3rd Boot Device		[xx,xxx-xxxxx:xxx] [xx,xxx-xxxxx:xxx] [xx,xxx-xxxxx:xxx]		A device enclosed in parenthesis has been disabled in the corresponding type menu.		
					↑ ↓ Selection +/- Cha F1 Gen	nge Option eral Help e and Exit

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Feature	Option	Description
Boot Device Priority		
1st Boot Device 2nd Boot Device	xx,xxx-xxxxx:xxx	Settings for boot priority. These can be customized
3rd Boot Device	xx,xxx-xxxxx:xxx Disabled	depending on your preference.

3.7.3 - Removable Drives Sub-Menu

Use this screen to select options for the Removable Drives. Use the up and down arrow (\uparrow / \downarrow) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option.

		BIOS	Setup Uti	lity		
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit
Removable	Drives				Specifies th	
1st Drive		[1st FL0	OPPY DR	RIVE]	sequence for available de	
						Item ge Option ral Help

Feature	Option	Description
Removable Drives		
	1st FLOPPY DRIVE	Specifies the boot sequence
1st Drive	xxxxxxxxx	for removable drive booting. This option will show all
	Disabled	removable devices.

3.8 - BIOS Security Menu

The system can be configured so that all users must enter a password every time the system boots or when BIOS Setup is entered, using either the Supervisor password or User password. The Supervisor and User passwords activate two different levels of password security. If you select password support, you are prompted for a one to six character password. Type the password on the keyboard. The password does not appear on the screen when typed. Make sure you write it down. If you forget it, you must clear CMOS and reconfigure.

BIOS Setup Utility	
Main Advanced PCI/PnP Boot Security	Chipset Exit
Security Settings	Install or change the password.
Supervisor Password : Not Installed User Password : Not Installed	← → Select Screen
Change Supervisor Password Change User Password	↑
Boot Sector Virus Protection [Disabled]	F10 Save and Exit ESC Exit

Feature	Option	Description
Security Settings		
Supervisor Password:	Not Installed	If the password has been set,
Supervisor Password.	Installed	Installed displays. If no password is set, Not Installed displays.
User Password:	Not Installed	If the password has been set, Installed displays. If no password
OSCI I assword.	Installed	is set, Not Installed displays.
Change Supervisor Password		Selects this option to change or install Supervisor Password.
Change User Password		Selects this option to change or install User Password.
	Disabled	When it is set to [Enabled], BIOS will issue a virus warning
Boot Sector Virus Protection	Enabled	message and beep if a write to the boot sector or the partition table of the HDD is attempted.

3.9 - BIOS Chipset Menu

		BIOS	Setup U	tility		
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit
	ge Configurati South Bridge C				Options for N → Select ↑ Select I +/- Chang Enter Go to S F1 Genera F10 Save a ESC Exit	Screen tem e Option Sub Screen al Help

3.9.1 - North Bridge Chipset Configuration Sub-Menu

This menu gives options for customizing memory & Hypertransport settings. Select a menu by highlighting it using the Arrow (\uparrow / \downarrow) keys and pressing Enter. The settings are described on the following pages.

BIOS Setup Utility						
Main Advanced		•	•	Chipset	Exit	
NorthBridge Chipset Co	nfiguration			← → Select	Screen	
 Memory Configuration ECC Configuration IOMMU Option Configuration 	uration			↑ ↓ Select I Enter Go to : F1 Genera F10 Save a	Sub Screen al Help	
Memory CLK CAS latency (Tcl) RAS/CAS Delay (Trcd) Min Active RAS (Tras) Row Precharge Time (Trr RAS/RAS Delay (Trrd) Row Cycle (Trc) Row Refresh Cycle (Trfc) Read Write Delay (Trwt) Read Preamble Asynchronous Latency	:X CLK :X CLK :X CLK :X CLK :X CLK :X CLK :X CLK :X CLK :X ns			ESC Exit		

<u>Feature</u>	<u>Option</u>	<u>Description</u>
NorthBridge Chipset Con	figuration	
Memory CLK	Read only	It shows the clock frequency of the installed SDRAM.
CAS Latency (Tcl)	Read only	This controls the timing delay (in clock cycles) before SDRAM starts a read command after receiving it.
RAS/CAS Delay (Trcd)	Read only	When DRAM is refreshed, both rows and columns are addressed separately. This setup item allows you to determine the timing of the transition from RAS (row address strobe) to CAS (column address strobe). The less the clock cycles, the faster the DRAM performance.
Min Active RAS (Tras)	Read only	This setting allows you to select the number of clock cycles allotted for the RAS pulse width, according to DRAM specifications. The less the clock cycles, the faster the DRAM performance.
Row Precharge Time (Trp)	Read only	This item controls the number of cycles for Row Address Strobe (RAS) to be allowed to precharge. If insufficient time is allowed for the RAS to accumulate its chage before DRAM refresh, refresh may be incomplete and DRAM may fail to retain data. This item applies only when synchronous DRAM is installed in the system.
RAS/RAS Delay (Trrd)	Read only	Auto uses hardware compensation values. Other values add to or subtract from hardware generated value. Recommended setting is Auto.
Row Cycle (Trc)	Read only	Bits 7-4. RAS#-active to RAS#-active or auto refresh of the same bank.
Row Refresh Cycle (Trfc)	Read only	Bits 11-8. Auto-refresh-active to RAS#-active or RAS# auto-refresh.

<u>Feature</u>	<u>Option</u>	<u>Description</u>			
NorthBridge Chipset Configuration					
Read Write Delay (Trwt)	Read only	Bits 6-4. Specifies the read-to-write delay. This is not a DRAM-specified timing parameter, but must be considered due to routing latencies on the clock forwarded bus. It is counted from the first address bus slot that was not associated with part of the read burst.			
Read Preamble	Read only	Bits 11-8. The time prior to the max- read DQS-return when the DQS receiver should be turned on. This is specified in units of 0.5ns. The controller needs to know when to enable its DQS receiver in anticipation of the DRAM DQS driver turning on for a read. The controller will disable its DQS receiver until the read preamble time and then enable its DQS receiver while the DRAM asserts DQS.			
Asynchronous Latency	Read only	Bits 3-0. This filed should be loaded with a 4-bit value equal to the maximum asynchronous latency in the DRAM read round-trip loop.			

3.9.1.1 – Memory Configuration Sub-Menu

This menu has options for memory speed & latency. Use the up and down arrow (\uparrow/\downarrow) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option.

Bl Main Advanced PCI/Pn	Utility Security Chipset Exit
Memory Configuration	MEMCLK can be set by the code using AUTO, or if you use
Memclock Mode MCT Timing Mode User Config Mode	o] LIMIT, you can set o] one of the standard o] values.
Burst Length SoftWare Memory Hole HardWare Memory Hole	eats] abled] ← → Select Screen abled] ↑ ↓ Select Item
CPU1 Mem DQ Driver Strength CPU2 Mem DQ Driver Strength	Reduction] +/- Change Option F1 General Help F10 Save and Exit ESC Exit

Feature	Option	Description
Memory Configuration		
Memclock Mode	Limit	MEMCLK can be set by the code using AUTO, or if you use LIMIT,
Welliologic Wode	Auto	you can set one of the standard values.
MCT Timing Mode	Manual Auto	Allows user to configure the MCT Timing Mode manually.
User Config Mode	Manual	Allows user to set the User Config
Oser Comig Mode	Auto	Mode manually.
	8 Beats	Burst length can be set to 8 or 4
Burst Length	4 Beats	beats. 64 bit DQ must use 4 beats.
	2 Beats	
SoftWare Memory Hole Disabled		Allows user to enable software /
HardWare Memory Hole	Enabled	hardware memory remapping around memory hole.
CPU1 Mem DQ Driver	No Reduction	This field controls the drive strength
Strength	-15%	reduction of the Memory DQ pins.
CPU2 Mem DQ Driver	-30%	
Strength	-50%	

3.9.1.2 -ECC Configuration Sub-Menu

This menu allows the user to configure ECC setup for system & DRAM. Use the up and down arrow (\uparrow/\downarrow) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option.

BIOS Setup Utility						
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit
ECC Configuration					DRAM ECC allows hardware to report and	
ECC Chi	AM ECC Logg p Kill CRUB REDIR G Scrub	,	Ena [Disa [Disa [Disa [Disa	bled] bled] abled] abled] abled] abled] abled]	automatica maintaining integrity. → Select † Select +/- Chan F1 Gene	g system ct Screen

Feature	Option	Description
ECC Configuration	Option	Description
DRAM ECC Enable	Enabled	DRAM ECC allows hardware to report and correct memory errors automatically maintaining system
BIVAWI EGO ENABIC	Disabled	integrity.
MCA DRAM ECC	Disabled	Enables MCA DRAM ECC Logging
Logging	Enabled	Reporting.
ECC Chip Kill	Disabled Enabled	ECC Chip Kill
DRAM SCRUB REDIRECT	Disabled	DRAM SCRUB REDIRECT allows the system to correct DRAM ECC errors immediately when they occur,
REDIRECT	Enabled	even if background scrubbing is on.
	Disabled	DRAM scrubbing corrects memory
	40ns	errors so later reads are correct.
	80ns	Doing this while memory is not being used improves performance.
	160ns	Note: When AMD's node interleave
	320ns	feature is enabled, BIOS will force
	640ns	DRAM scrub off.
	1.28us	
DRAM BG Scrub	2.56us	
	5.12us	
	10.2us	
	20.5us	
	41.0us	
	81.9us	
	163.8us	
	327.7us	
	655.4us	Allows the LO Date Cooks DAM to
	Disabled	Allows the L2 Data Cache RAM to be corrected while idle.
	40ns 80ns	De corrected writte luie.
	160ns	
	320ns	
	640ns	
	1.28us	
	2.56us	
L2 Cache BG Scrub	5.12us	
	10.2us	
	20.5us	
	41.0us	
	81.9us	
	163.8us	
	327.7us	
	655.4us	
	555.146	

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Feature	Option	Description
ECC Configuration		
ECC Configuration Data Cache BG Scrub	Disabled 40ns 80ns 160ns 320ns 640ns 1.28us 2.56us	Allows the L1 Data Cache RAM to be corrected while idle.
	5.12us 10.2us 20.5us 41.0us	
	81.9us 163.8us 327.7us 655.4us	

3.9.1.3 – IOMMU Configuration Sub-MenuThis menu has options for IOMMU. Use the up and down arrow (\uparrow / \downarrow) keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option.

		BIOS	Setup Ut	tility		
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit
IOMMU Mod	le		[Disable	ad]		thout AGP, altogether. s require for proper If AGP is lect option to per AGP at Screen t Item ge Option ral Help

Feature	Option	Description
IOMMU Configuration		
	AGP Present	
	Disabled	Set GART size in systems without
	32 MB	AGP, or disable altogether. Some
IOMMU Mode	64 MB	OSes require valid GART for proper operation, If AGP is present, select
IOMINIO Mode	128 MB	appropriate option to ensure proper
	256 MB	AGP operation.
	512 MB	·
	1 GB	

3.9.2 - HT 1000 SouthBridge Chipset Configuration Sub-Menu

This menu allows the user to enable SM Bus 2.0 controller. Use the up and down arrow $(\uparrow \land \psi)$ keys to select an item. Use the Plus and Minus (+/-) keys to change the value of the selected option.

e selected opti	011.					
BIOS Setup Utility						
Main	Advanced	PCI/PnP	Boot	Security	Chipset	Exit
Power Contr Resume on Resume on		r Fail	[[visabled] visabled] vinabled]	F1 Gene	t Screen
Hide XIOAP Power Butto	IC PCI Function	ons		nabled] nabled]	ESC Exit	

Feature	Option	Description
Chipset Configuration		
Power Control After Power Fail	Former State	
	Disabled	
Resume on RTC Alarm	Enabled	
	Disabled	
Resume on PME#	Enabled	
Resulte of FiviL#	Disabled	

Feature	Option	Description
South ridge Chipset Co		
Hide XIOAPIC PCI Functions	Enabled	Hide XIOAPIC PCI functions.
Functions	Disabled	Tilde Aloapic Foliulictions.
Power Button Install Off	Enabled	Disable or enable power button
Power Bullon Install Off	Disabled	instant off.

3.10 - BIOS Exit Menu

BIOS Setup Utility					
Main Advanced	PCI/PnP	Boot	Security	/ Chipset	Exit
Exit Options				Exit system setup after saving the changes.	
Save Changes and Exit Discard Changes and Exit Discard Charges				F10 key can be this operation	
Load Optimal Defaults Load Failsafe Defaults				← → Select Screen † ↓ Select Item Enter Go to Sub Screer F1 General Help F10 Save and Exit ESC Exit	

Save Changes and Exit

Use this option to exit setup utility and re-boot. All new selections you have made are stored into CMOS. System will use the new settings to boot up.

Discard Changes and Exit

Use this option to exit setup utility and re-boot.
All new selections you have made are not stored into CMOS.
System will use the old settings to boot up.

Discard Changes

Use this option to restore all new setup values that you have made but not saved into CMOS.

Load Optimal Defaults

Use this option to load default performance setup values.

Use this option when system CMOS values have been corrupted or modified incorrectly.

Load Failsafe Defaults

Use this option to load all default failsafe setup values.

Use this option when troubleshooting

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Chapter 4: Diagnostics

Note: if you experience problems with setting up your system, always check the following things in the following order:

CPU, Memory, Video

By checking these items, you will most likely find out what the problem might have been when setting up your system. For more information on troubleshooting, check the Tyan website at: http://www.tyan.com.

4.00 Beep Codes

Fatal errors which halt the boot process are communicated through a series of audible beeps.

- (1) Memory module initialization failed
 - (a) memory modules might not be plugged in correct configuration
 - (b) wrong type of memory
 - (c) bad memory modules
- (2) Graphics initialization failed

Before contacting your vendor or Tyan Technical Support, be sure that you note as much as you can about the beep code length and order that you experience. Also, be ready with information regarding add-in cards, drives and O/S to speed the support process and come to a quicker solution.

4.01 Flash Utility

Every BIOS file is unique for the motherboard it was designed for. For Flash Utilities, BIOS downloads, and information on how to properly use the Flash Utility with your motherboard, please check the Tyan web site: http://www.tyan.com

NOTE

Please be aware that by flashing your BIOS, you agree that in the event of a BIOS flash failure, you must contact your dealer for a replacement BIOS. There are no exceptions. Tyan does not have a policy for replacing BIOS chips directly with end users. In no event will Tyan be held responsible for damages done by the end user.

Appendix: Glossary

ACPI (Advanced Configuration and Power Interface): a power management specification that allows the operating system to control the amount of power distributed to the computer's devices. Devices not in use can be turned off, reducing unnecessary power expenditure.

AGP (Accelerated Graphics Port): a PCI-based interface which was designed specifically for demands of 3D graphics applications. The 32-bit AGP channel directly links the graphics controller to the main memory. While the channel runs only at 66 MHz, it supports data transmission during both the rising and falling ends of the clock cycle, yielding an effective speed of 133 MHz.

ATAPI (AT Attachment Packet Interface): also known as IDE or ATA; a drive implementation that includes the disk controller on the device itself. It allows CD-ROMs and tape drives to be configured as master or slave devices, just like HDDs.

ATX: the form factor designed to replace the AT form factor. It improves on the AT design by rotating the board 90 degrees, so that the IDE connectors are closer to the drive bays, and the CPU is closer to the power supply and cooling fan. The keyboard, mouse, USB, serial, and parallel ports are built-in.

Bandwidth: refers to carrying capacity. The greater the bandwidth, the more data the bus, phone line, or other electrical path can carry. Greater bandwidth results in greater speed.

BBS (BIOS Boot Specification): a feature within the BIOS that creates, prioritizes, and maintains a list of all Initial Program Load (IPL) devices, and then stores that list in NVRAM. IPL devices have the ability to load and execute an OS, as well as provide the ability to return to the BIOS if the OS load process fails. At that point, the next IPL device is called upon to attempt loading of the OS.

BIOS (Basic Input/Output System): the program that resides in the ROM chip, which provides the basic instructions for controlling your computer's hardware. Both the operating system and application software use BIOS routines to ensure compatibility.

Buffer: a portion of RAM which is used to temporarily store data; usually from an application though it is also used when printing and in most keyboard drivers. The CPU can manipulate data in a buffer before copying it to a disk drive. While this improves system performance (reading to or writing from a disk drive a single time is much faster than doing so repeatedly) there is the possibility of losing your data should the system crash. Information in a buffer is temporarily stored, not permanently saved.

Bus: a data pathway. The term is used especially to refer to the connection between the processor and system memory, and between the processor and PCI or ISA local buses.

Bus mastering: allows peripheral devices and IDEs to access the system memory without going through the CPU (similar to DMA channels).

Cache: a temporary storage area for data that will be needed often by an application. Using a cache lowers data access times since the information is stored in SRAM instead of slower DRAM. Note that the cache is also much smaller than your regular memory: a typical cache size is 512KB, while you may have as much as 4GB of regular memory.

Closed and open jumpers: jumpers and jumper pins are active when they are "on" or "closed", and inactive when they are "off" or "open".

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CMOS (Complementary Metal-Oxide Semiconductors): chips that hold the basic startup information for the BIOS.

COM port: another name for the serial port, which is called as such because it transmits the eight bits of a byte of data along one wire, and receives data on another single wire (that is, the data is transmitted in serial form, one bit after another). Parallel ports transmit the bits of a byte on eight different wires at the same time (that is, in parallel form, eight bits at the same time).

DDR (Double Data Rate): a technology designed to double the clock speed of the memory. It activates output on both the rising and falling edge of the system clock rather than on just the rising edge, potentially doubling output.

DIMM (Dual In-line Memory Module): faster and more capacious form of RAM than SIMMs, and do not need to be installed in pairs.

DIMM bank: sometimes called DIMM socket because the physical slot and the logical unit are the same. That is, one DIMM module fits into one DIMM socket, which is capable of acting as a memory bank.

DMA (Direct Memory Access): channels that are similar to IRQs. DMA channels allow hardware devices (like soundcards or keyboards) to access the main memory without involving the CPU. This frees up CPU resources for other tasks. As with IRQs, it is vital that you do not double up devices on a single line. Plug-n-Play devices will take care of this for you.

DRAM (Dynamic RAM): widely available, very affordable form of RAM which looses data if it is not recharged regularly (every few milliseconds). This refresh requirement makes DRAM three to ten times slower than non-recharged RAM such as SRAM.

ECC (Error Correction Code or Error Checking and Correcting): allows data to be checked for errors during run-time. Errors can subsequently be corrected at the same time that they're found.

EEPROM (Electrically Erasable Programmable ROM): also called Flash BIOS, it is a ROM chip which can, unlike normal ROM, be updated. This allows you to keep up with changes in the BIOS programs without having to buy a new chip. TYAN's BIOS updates can be found at http://www.tyan.com

ESCD (Extended System Configuration Data): a format for storing information about Plug-n-Play devices in the system BIOS. This information helps properly configure the system each time it boots.

Firmware: low-level software that controls the system hardware.

Form factor: an industry term for the size, shape, power supply type, and external connector type of the Personal Computer Board (PCB) or motherboard. The standard form factors are the AT and ATX.

Global timer: onboard hardware timer, such as the Real-Time Clock (RTC).

HDD: stands for Hard Disk Drive, a type of fixed drive.

H-SYNC: controls the horizontal synchronization/properties of the monitor.

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HyperTransport[™]: a high speed, low latency, scalable point-to-point link for interconnecting ICs on boards. It can be significantly faster than a PCI bus for an equivalent number of pins. It provides the bandwidth and flexibility critical for today's networking and computing platforms while retaining the fundamental programming model of PCI.

IC (Integrated Circuit): the formal name for the computer chip.

IDE (Integrated Device/Drive Electronics): a simple, self-contained HDD interface. It can handle drives up to 8.4 GB in size. Almost all IDEs sold now are in fact Enhanced IDEs (EIDEs), with maximum capacity determined by the hardware controller.

IDE INT (IDE Interrupt): a hardware interrupt signal that goes to the IDE.

I/O (Input/Output): the connection between your computer and another piece of hardware (mouse, keyboard, etc.)

IRQ (Interrupt Request): an electronic request that runs from a hardware device to the CPU. The interrupt controller assigns priorities to incoming requests and delivers them to the CPU. It is important that there is only one device hooked up to each IRQ line; doubling up devices on IRQ lines can lock up your system. Plug-n-Play operating systems can take care of these details for you.

Latency: the amount of time that one part of a system spends waiting for another part to catch up. This occurs most commonly when the system sends data out to a peripheral device and has to wait for the peripheral to spread (peripherals tend to be slower than onboard system components).

NVRAM: ROM and EEPROM are both examples of Non-Volatile RAM, memory that holds its data without power. DRAM, in contrast, is volatile.

Parallel port: transmits the bits of a byte on eight different wires at the same time.

PCI (Peripheral Component Interconnect): a 32 or 64-bit local bus (data pathway) which is faster than the ISA bus. Local buses are those which operate within a single system (as opposed to a network bus, which connects multiple systems).

PCI PIO (PCI Programmable Input/Output) modes: the data transfer modes used by IDE drives. These modes use the CPU for data transfer (in contrast, DMA channels do not). PCI refers to the type of bus used by these modes to communicate with the CPU.

PCI-to-PCI bridge: allows you to connect multiple PCI devices onto one PCI slot.

Pipeline burst SRAM: a fast secondary cache. It is used as a secondary cache because SRAM is slower than SDRAM, but usually larger. Data is cached first to the faster primary cache, and then, when the primary cache is full, to the slower secondary cache.

PnP (Plug-n-Play): a design standard that has become ascendant in the industry. Plug-n-Play devices require little set-up to use. Devices and operating systems that are not Plug-n-Play require you to reconfigure your system each time you add or change any part of your hardware.

PXE (Preboot Execution Environment): one of four components that together make up the Wired for Management 2.0 baseline specification. PXE was designed to define a

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standard set of preboot protocol services within a client with the goal of allowing networked-based booting to boot using industry standard protocols.

RAID (Redundant Array of Independent Disks): a way for the same data to be stored in different places on many hard drives. By using this method, the data is stored redundantly and multiple hard drives will appear as a single drive to the operating system. RAID level 0 is known as striping, where data is striped (or overlapped) across multiple hard drives, but offers no fault-tolerance. RAID level 1 is known as mirroring, which stores the data within at least two hard drives, but does not stripe. RAID level 1 also allows for faster access time and fault-tolerance, since either hard drive can be read at the same time. RAID level 0+1 is both striping and mirroring, providing fault-tolerance, striping, and faster access all at the same time.

RAIDIOS: RAID I/O Steering (Intel)

RAM (Random Access Memory): technically refers to a type of memory where any byte can be accessed without touching the adjacent data and is often referred to the system's main memory. This memory is available to any program running on the computer.

ROM (Read-Only Memory): a storage chip which contains the BIOS; the basic instructions required to boot the computer and start up the operating system.

SDRAM (Synchronous Dynamic RAM): called as such because it can keep two sets of memory addresses open simultaneously. By transferring data alternately from one set of addresses and then the other, SDRAM cuts down on the delays associated with non-synchronous RAM, which must close one address bank before opening the next.

Serial port: called as such because it transmits the eight bits of a byte of data along one wire, and receives data on another single wire (that is, the data is transmitted in serial form, one bit after another).

SCSI Interrupt Steering Logic (SISL): Architecture that allows a RAID controller, such as AcceleRAID 150, 200 or 250, to implement RAID on a system board-embedded SCSI bus or a set of SCSI busses. SISL: SCSI Interrupt Steering Logic (LSI) (only on LSI SCSI boards)

Sleep/Suspend mode: in this mode, all devices except the CPU shut down.

SDRAM (Static RAM): unlike DRAM, this type of RAM does not need to be refreshed in order to prevent data loss. Thus, it is faster and more expensive.

Standby mode: in this mode, the video and hard drives shut down; all other devices continue to operate normally.

UltraDMA-33/66/100: a fast version of the old DMA channel. UltraDMA is also called UltraATA. Without a proper UltraDMA controller, your system cannot take advantage of higher data transfer rates of the new UltraDMA/UltraATA hard drives.

USB (Universal Serial Bus): a versatile port. This one port type can function as a serial, parallel, mouse, keyboard or joystick port. It is fast enough to support video transfer, and is capable of supporting up to 127 daisy-chained peripheral devices.

VGA (Video Graphics Array): the PC video display standard

V-SYNC: controls the vertical scanning properties of the monitor.

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ZCR (Zero Channel RAID): PCI card that allows a RAID card to use the onboard SCSI chip, thus lowering cost of RAID solution

ZIF Socket (Zero Insertion Force socket): these sockets make it possible to insert CPUs without damaging the sensitive CPU pins. The CPU is lightly placed in an open ZIF socket, and a lever is pulled down. This shifts the processor over and down, guiding it into the board and locking it into place.

Technical Support

If a problem arises with your system, you should first turn to your dealer for direct support. Your system has most likely been configured or designed by them and they should have the best idea of what hardware and software your system contains. Hence, they should be of the most assitance for you. Furthermore, if you purchased your system from a dealer near you, take the system to them directly to have it serviced instead of attempting to do so yourself (which can have expensive consequences).

If these options are not available for you then Tyan Computer Corporation can help. Besides designing innovative and quality products for over a decade, Tyan has continuously offered customers service beyond their expectations. Tyan's website (www.tyan.com) provides easy-to-access resources such as in-depth Linux Online Support sections with downloadable Linux drivers and comprehensive compatibility reports for chassis, memory and much more. With all these convenient resources just a few keystrokes away, users can easily find the latest software and operating system components to keep their systems running as powerful and productive as possible. Tyan also ranks high for its commitment to fast and friendly customer support through email. By offering plenty of options for users, Tyan serves multiple market segments with the industry's most competitive services to support them.

"Tyan's tech support is some of the most impressive we've seen, with great response time and exceptional organization in general" - Anandtech.com

Please feel free to contact us directly for this service at techsupport@tyan.com

Help Resources:

- 1. See the beep codes section of this manual.
- 2. See the TYAN website for FAQ's, bulletins, driver updates, and other information: http://www.tyan.com
- 3. Contact your dealer for help BEFORE calling TYAN.
- 4. Check the TYAN user group: alt.comp.periphs.mainboard.TYAN

Returning Merchandise for Service

During the warranty period, contact your distributor or system vendor FIRST for any product problems. This warranty only covers normal customer use and does not cover damages incurred during shipping or failure due to the alteration, misuse, abuse, or improper maintenance of products.

NOTE: A receipt or copy of your invoice marked with the date of purchase is required before any warranty service can be rendered. You may obtain service by calling the manufacturer for a Return Merchandise Authorization (RMA) number. The RMA number should be prominently displayed on the outside of the shipping carton and the package should be mailed prepaid. TYAN will pay to have the board shipped back to you

FC

Notice for the USA

Compliance Information Statement (Declaration of Conformity Procedure) DoC FCC Part 15: This device complies with part 15 of the FCC Rules

Operation is subject to the following conditions:

This device may not cause harmful interference, and

This device must accept any interference received including interference that may cause undesired operation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try one or more of the following measures:

Reorient or relocate the receiving antenna.

Increase the separation between the equipment and the receiver.

Plug the equipment into an outlet on a circuit different from that of the receiver.

Consult the dealer on an experienced radio/television technician for help.

Notice for Canada

This apparatus complies with the Class B limits for radio interference as specified in the Canadian Department of Communications Radio Interference Regulations. (Cet appareil est conforme aux norms de Classe B d'interference radio tel que specifie par le Ministere Canadien des Communications dans les reglements d'ineteference radio.)



Notice for Europe (CE Mark)
This product is in conformity with the Council Directive 89/336/EEC, 92/31/EEC (EMC).

CAUTION: Lithium battery included with this board. Do not puncture, mutilate, or dispose of battery in fire. Danger of explosion if battery is incorrectly replaced. Replace only with the same or equivalent type recommended by manufacturer. Dispose of used battery according to manufacturer instructions and in accordance with your local regulations.

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